

# MITSUBISHI IGBT MODULES

## CM100MX-12A

HIGH POWER SWITCHING USE

### CM100MX-12A

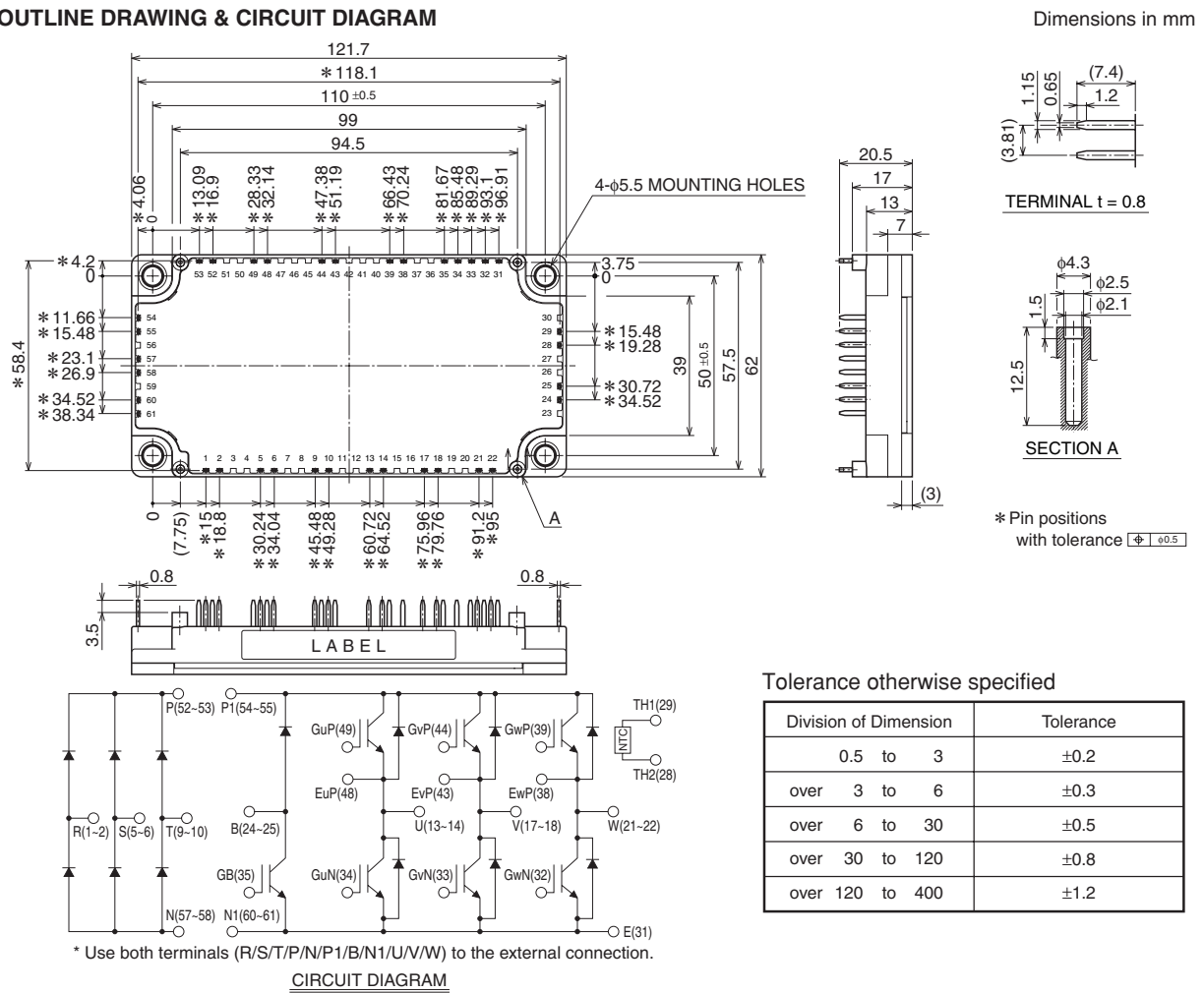


- Ic ..... 100A
- VCES ..... 600V
- CIB (3-phase Converter + 3-phase Inverter + Brake)
- Flatbase Type / Insulated Package / Copper base plate
- RoHS Directive compliant

### APPLICATION

General purpose Inverters, Servo Amplifiers

### OUTLINE DRAWING & CIRCUIT DIAGRAM



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ABSOLUTE MAXIMUM RATINGS (Tj = 25°C, unless otherwise specified)

INVERTER PART

Symbol	Parameter	Conditions	Rating	Unit
V <sub>CES</sub>	Collector-emitter voltage	G-E Short	600	V
V <sub>GES</sub>	Gate-emitter voltage	C-E Short	±20	
I <sub>C</sub>	Collector current	DC, T <sub>c</sub> = 75°C (Note. 1)	100	A
I <sub>CRM</sub>		Pulse (Note. 4)	200	
P <sub>C</sub>	Maximum collector dissipation	T <sub>c</sub> = 25°C (Note. 1, 5)	400	W
I <sub>E</sub> (Note.3)	Emitter current	T <sub>c</sub> = 25°C (Note. 1)	100	A
I <sub>ERM</sub> (Note.3)	(Free wheeling diode forward current)	Pulse (Note. 4)	150	

BRAKE PART

Symbol	Parameter	Conditions	Rating	Unit
V <sub>CES</sub>	Collector-emitter voltage	G-E Short	600	V
V <sub>GES</sub>	Gate-emitter voltage	C-E Short	±20	
I <sub>C</sub>	Collector current	DC, T <sub>c</sub> = 97°C (Note. 1)	50	A
I <sub>CRM</sub>		Pulse (Note. 4)	100	
P <sub>C</sub>	Maximum collector dissipation	T <sub>c</sub> = 25°C (Note. 1, 5)	280	W
V <sub>RRM</sub> (Note.3)	Repetitive peak reverse voltage		600	V
I <sub>F</sub> (Note.3)	Forward current	T <sub>c</sub> = 25°C (Note. 1)	50	A
I <sub>FRM</sub> (Note.3)		Pulse (Note. 4)	100	

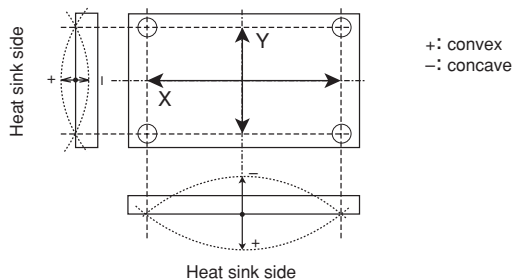
CONVERTER PART

Symbol	Parameter	Conditions	Rating	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		800	V
E <sub>a</sub>	Recommended AC input voltage		220	V <sub>rms</sub>
I <sub>O</sub>	DC output current	3-phase full wave rectifying, T <sub>c</sub> = 137°C (Note. 1)	100	A
I <sub>FSM</sub>	Surge forward current	The sine half wave 1 cycle peak value, f = 60Hz, non-repetitive	1000	
i <sup>2</sup> t	Current square time	Value for one cycle of surge current	4160	A <sup>2</sup> s

MODULE

Symbol	Parameter	Conditions	Rating	Unit
T <sub>j</sub>	Junction temperature		-40 ~ +150	°C
T <sub>stg</sub>	Storage temperature		-40 ~ +125	
V <sub>iso</sub>	Isolation voltage	Terminals to base plate, f = 60Hz, AC 1 minute	2500	V <sub>rms</sub>
—	Base plate flatness	On the centerline X, Y (Note. 8)	±0 ~ +100	µm
—	Torque strength	Mounting M5 screw	2.5 ~ 3.5	N·m
—	Weight	(Typical)	270	g

Note. 8: The base plate flatness measurement points are in the following figure.



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ELECTRICAL CHARACTERISTICS (T<sub>j</sub> = 25°C, unless otherwise specified)

INVERTER PART

Symbol	Parameter	Conditions	Limits			Unit	
			Min.	Typ.	Max.		
ICES	Collector cutoff current	VCE = VCES, VGE = 0V	—	—	1	mA	
VGE(th)	Gate-emitter threshold voltage	IC = 10mA, VCE = 10V	5	6	7	V	
IGES	Gate leakage current	±VGE = VGES, VCE = 0V	—	—	0.5	μA	
VCE(sat)	Collector-emitter saturation voltage	IC = 100A, VGE = 15V (Note. 6)	T <sub>j</sub> = 25°C	—	1.7	2.1	V
			T <sub>j</sub> = 125°C	—	1.9	—	
		IC = 100A, VGE = 15V	Chip	—	1.6	—	
Cies	Input capacitance	VCE = 10V VGE = 0V (Note. 6)	—	—	13.3	nF	
Coes	Output capacitance		—	—	1.4		
Cres	Reverse transfer capacitance		—	—	0.45		
QG	Total gate charge	VCC = 300V, IC = 100A, VGE = 15V	—	270	—	nC	
td(on)	Turn-on delay time	VCC = 300V, IC = 100A	—	—	100	ns	
tr	Turn-on rise time	VGE = ±15V, RG = 6.2Ω	—	—	100		
td(off)	Turn-off delay time	Inductive load	—	—	300		
tf	Turn-off fall time		—	—	600		
trr (Note.3)	Reverse recovery time		(IE = 100A)	—	—		200
Qrr (Note.3)	Reverse recovery charge		—	3.6	—	μC	
VEC(Note.3)	Emitter-collector voltage	IE = 100A, VGE = 0V (Note. 6)	T <sub>j</sub> = 25°C	—	2.0	2.8	V
			T <sub>j</sub> = 125°C	—	1.95	—	
		IE = 100A, VGE = 0V	Chip	—	1.9	—	
Rth(j-c)Q	Thermal resistance (Junction to case) (Note. 1)	per IGBT	—	—	0.31	K/W	
Rth(j-c)R		per free wheeling diode	—	—	0.59		
RGint	Internal gate resistance	Tc = 25°C, per switch	—	0	—	Ω	
RG	External gate resistance		6	—	62		

BRAKE PART

Symbol	Parameter	Conditions	Limits			Unit	
			Min.	Typ.	Max.		
ICES	Collector cutoff current	VCE = VCES, VGE = 0V	—	—	1	mA	
VGE(th)	Gate-emitter threshold voltage	IC = 5mA, VCE = 10V	5	6	7	V	
IGES	Gate leakage current	±VGE = VGES, VCE = 0V	—	—	0.5	μA	
VCE(sat)	Collector-emitter saturation voltage	IC = 50A, VGE = 15V (Note. 6)	T <sub>j</sub> = 25°C	—	1.7	2.1	V
			T <sub>j</sub> = 125°C	—	1.9	—	
		IC = 50A, VGE = 15V	Chip	—	1.6	—	
Cies	Input capacitance	VCE = 10V VGE = 0V (Note. 6)	—	—	9.3	nF	
Coes	Output capacitance		—	—	1.0		
Cres	Reverse transfer capacitance		—	—	0.3		
QG	Total gate charge	VCC = 300V, IC = 50A, VGE = 15V	—	200	—	nC	
IRRM(Note.3)	Repetitive peak reverse current	VR = VRRM	—	—	1	mA	
VFM(Note.3)	Forward voltage drop	IF = 50A (Note. 6)	T <sub>j</sub> = 25°C	—	2.0	2.8	V
			T <sub>j</sub> = 125°C	—	1.95	—	
		IF = 50A	Chip	—	1.9	—	
Rth(j-c)Q	Thermal resistance (Junction to case) (Note. 1)	per IGBT	—	—	0.44	K/W	
Rth(j-c)R		per Clamp diode	—	—	0.85		
RGint	Internal gate resistance	Tc = 25°C	—	0	—	Ω	
RG	External gate resistance		13	—	125		

CONVERTER PART

Symbol	Parameter	Conditions	Limits			Unit
			Min.	Typ.	Max.	
IRRM	Repetitive peak reverse current	VR = VRRM, T <sub>j</sub> = 150°C	—	—	20	mA
VF	Forward voltage drop	IF = 100A	—	1.2	1.6	V
Rth(j-c)	Thermal resistance (Junction to case) (Note. 1)	per Diode	—	—	0.24	K/W

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## NTC THERMISTOR PART

Symbol	Parameter	Conditions	Limits			Unit
			Min.	Typ.	Max.	
R	Zero power resistance	Tc = 25°C	4.85	5.00	5.15	kΩ
ΔR/R	Deviation of resistance	Tc = 100°C, R100 = 493Ω	-7.3	—	+7.8	%
B(25/50)	B constant	Approximate by equation (Note. 7)	—	3375	—	K
P25	Power dissipation	Tc = 25°C	—	—	10	mW

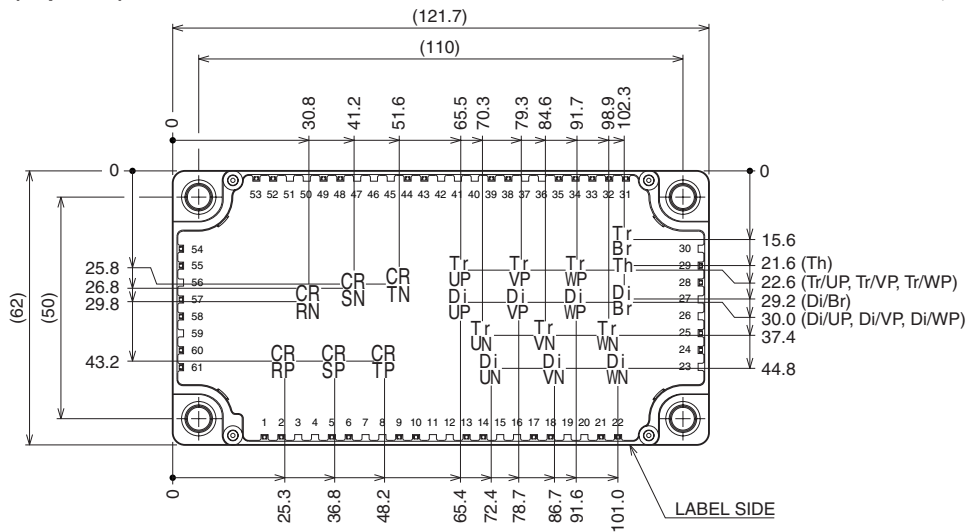
## MODULE

Symbol	Parameter	Conditions	Limits			Unit
			Min.	Typ.	Max.	
Rth(c-f)	Contact thermal resistance (Case to fin) (Note. 1)	Thermal grease applied per 1 module (Note. 2)	—	0.015	—	K/W

- Note. 1: Case temperature (Tc), heat sink temperature (Tf) measured point is just under the chips. (Refer to the figure of the chip location.)  
 2: Typical value is measured by using thermally conductive grease of λ = 0.9W/(m·K).  
 3: IE, IERM, VEC, tr, Qrr and Err represent ratings and characteristics of the anti-parallel, emitter-collector free wheeling diode (FWDi).  
 IF, IFRM, VF, VRRM and IRRM represent ratings and characteristics of the Clamp diode of Brake part.  
 4: Pulse width and repetition rate should be such that the device junction temperature (Tj) dose not exceed Tjmax rating.  
 5: Junction temperature (Tj) should not increase beyond 150°C.  
 6: Pulse width and repetition rate should be such as to cause negligible temperature rise. (Refer to the figure of the test circuit for VCE(sat) and VEC)  
 7:  $B(25/50) = \ln\left(\frac{R_{25}}{R_{50}}\right) / \left(\frac{1}{T_{25}} - \frac{1}{T_{50}}\right)$   
 R25: resistance at absolute temperature T25 [K]; T25 = 25 [°C]+273.15 = 298.15 [K]  
 R50: resistance at absolute temperature T50 [K]; T50 = 50 [°C]+273.15 = 323.15 [K]

## Chip Location (Top view)

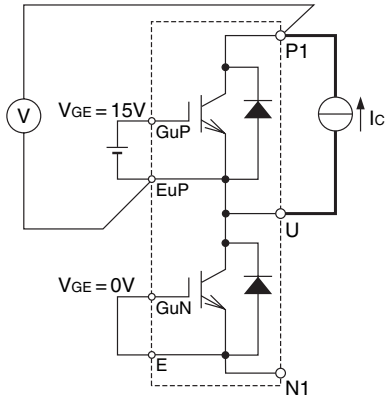
Dimensions in mm (tolerance: ±1mm)



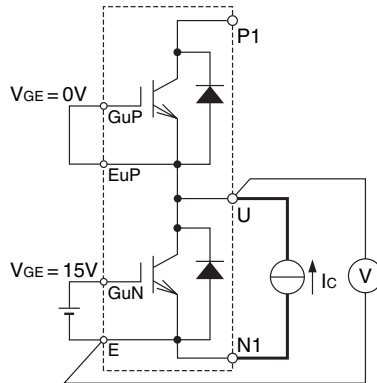
Each mark points the center position of each chip. Tr\*\*: IGBT, Di\*\*: FWDi (DiBr: Clamp diode), CR\*\*: Converter diode, Th: NTC thermistor

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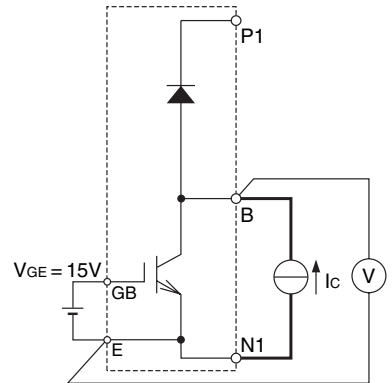
HIGH POWER SWITCHING USE



P side Inverter part Tr  
(example of U arm)  
 $V_{G^*E^*} = 0V$   
(GvP-EvP, GwP-EwP, GvN-E, GwN-E, GB-E)

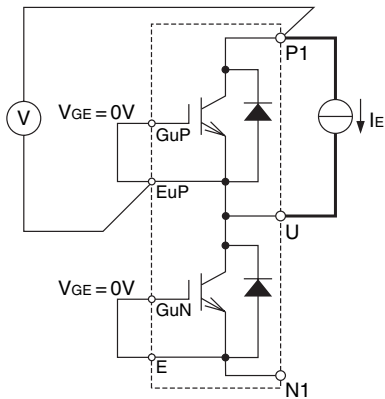


N side Inverter part Tr  
(example of U arm)  
 $V_{G^*E^*} = 0V$   
(GvP-EvP, GwP-EwP, GvN-E, GwN-E, GB-E)

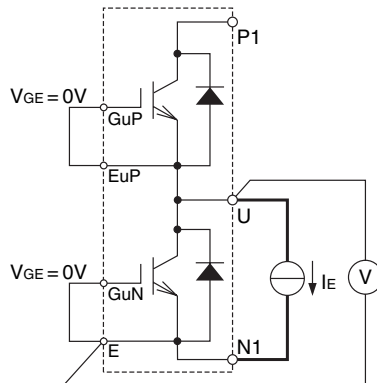


Br Tr  
 $V_{G^*E^*} = 0V$   
(GuP-EuP, GvP-EvP, GwP-EwP, GuN-E, GvN-E, GwN-E)

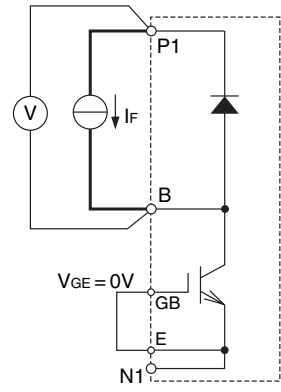
VCE(sat) test circuit



P side Inverter part Di  
(example of U arm)  
 $V_{G^*E^*} = 0V$   
(GvP-EvP, GwP-EwP, GvN-E, GwN-E, GB-E)

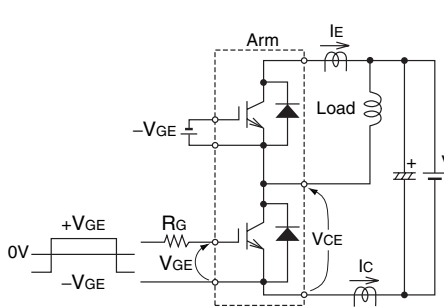


N side Inverter part Di  
(example of U arm)  
 $V_{G^*E^*} = 0V$   
(GvP-EvP, GwP-EwP, GvN-E, GwN-E, GB-E)

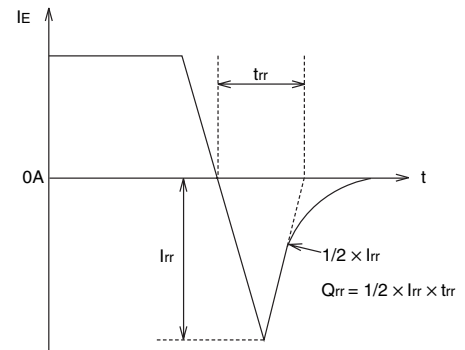
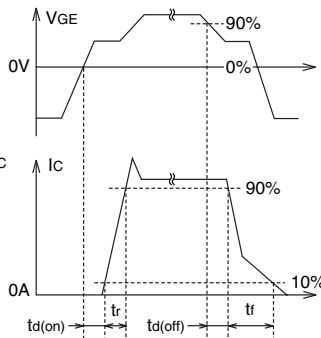


Br Di  
 $V_{G^*E^*} = 0V$   
(GuP-EuP, GvP-EvP, GwP-EwP, GuN-E, GvN-E, GwN-E)

Vec/VFM test circuit



Switching time test circuit and waveforms

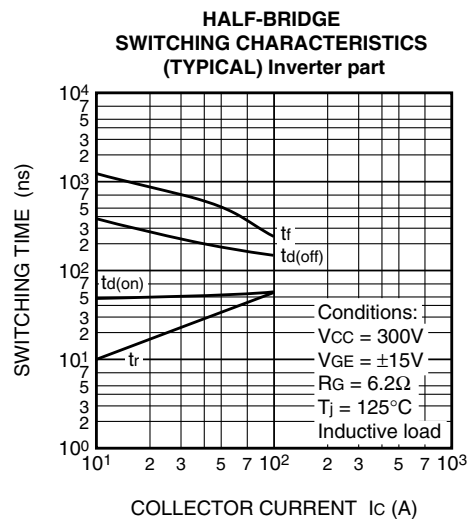
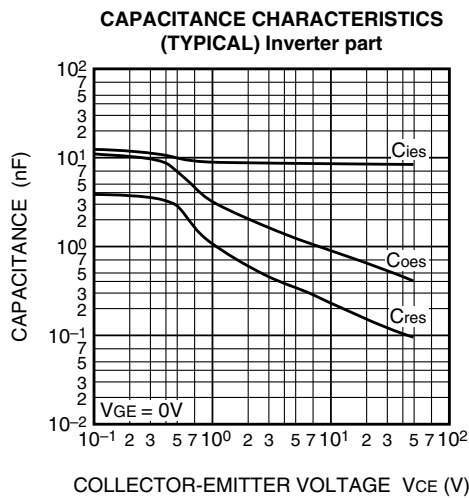
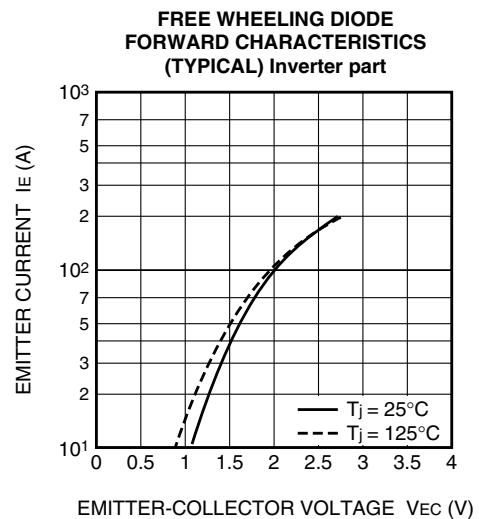
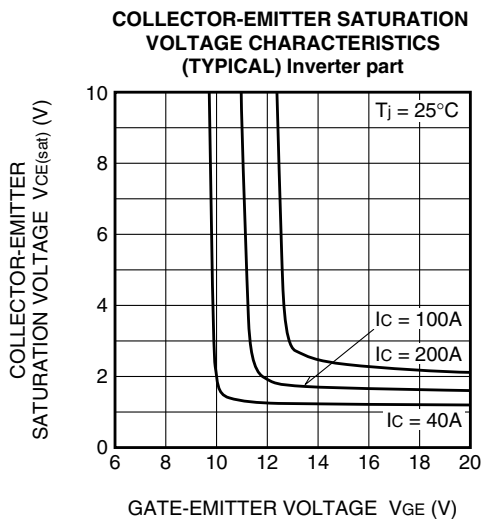
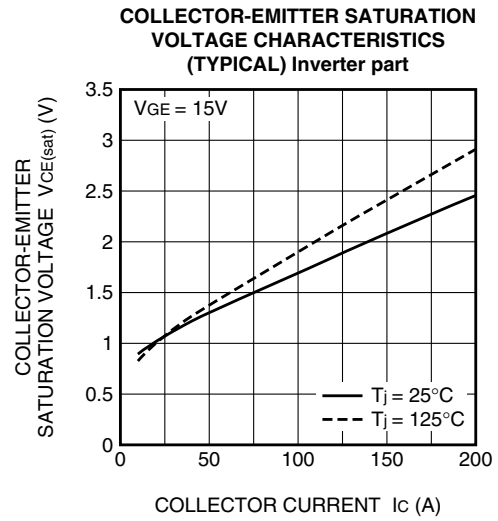
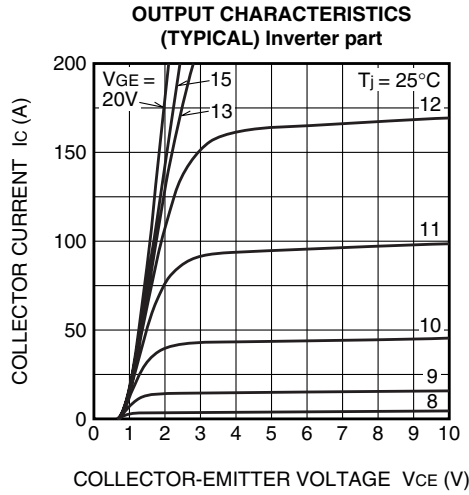


tr, Qrr test waveform

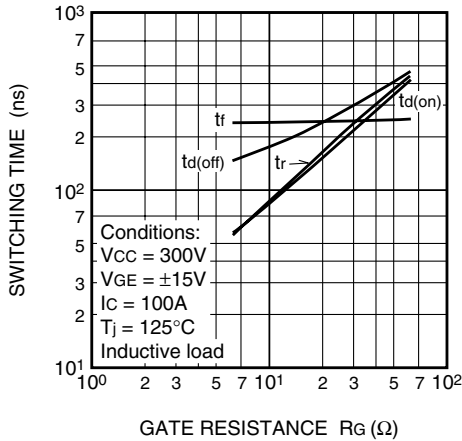
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HIGH POWER SWITCHING USE

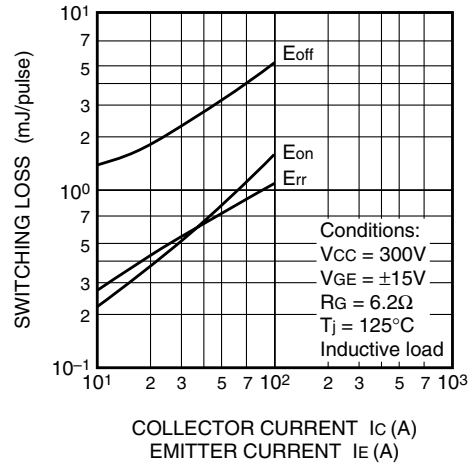
## PERFORMANCE CURVES



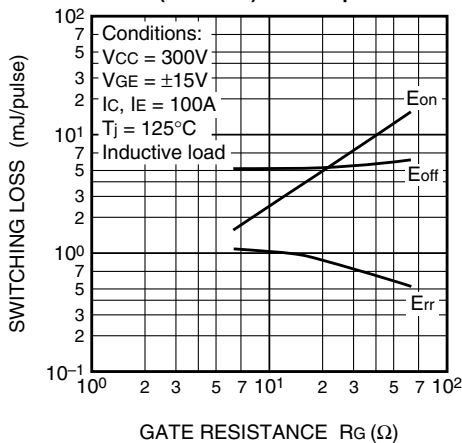
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL) Inverter part



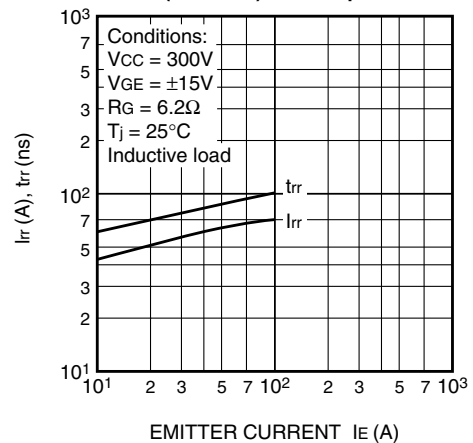
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL) Inverter part



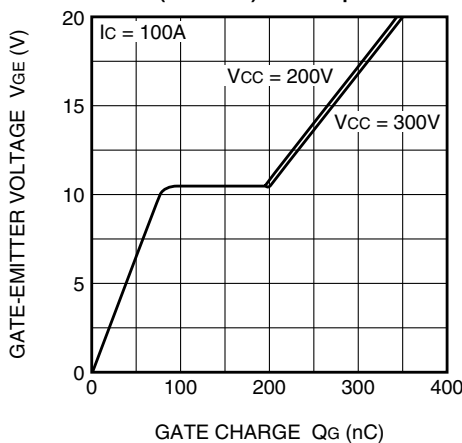
HALF-BRIDGE SWITCHING CHARACTERISTICS (TYPICAL) Inverter part



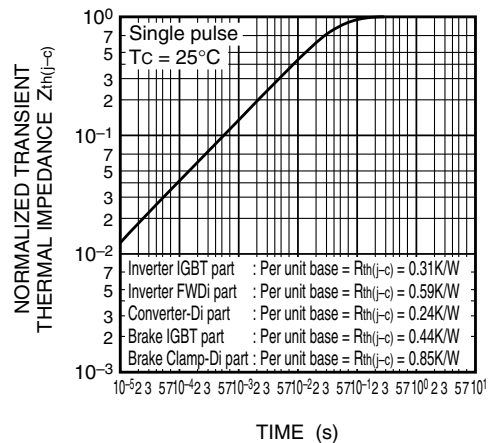
REVERSE RECOVERY CHARACTERISTICS OF FREE WHEELING DIODE (TYPICAL) Inverter part



GATE CHARGE CHARACTERISTICS (TYPICAL) Inverter part



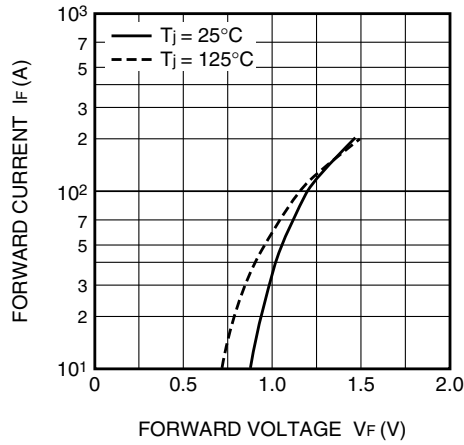
TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS



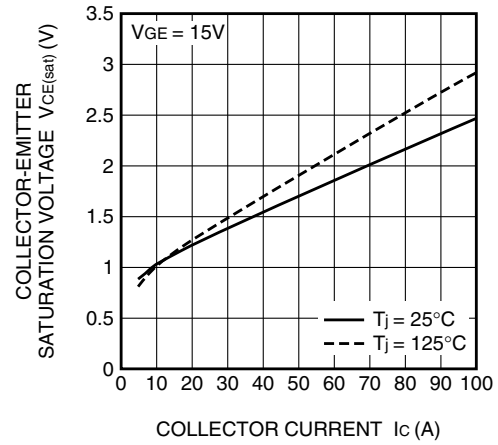
CM100MX-12A

HIGH POWER SWITCHING USE

**RECTIFIER DIODE  
FORWARD CHARACTERISTICS  
(TYPICAL) Converter part**



**COLLECTOR-EMITTER SATURATION  
VOLTAGE CHARACTERISTICS  
(TYPICAL) Brake part**



**CLAMP DIODE  
FORWARD CHARACTERISTICS  
(TYPICAL) Brake part**

